

## **MATERIALS**

- 1. INSULATION SLEEVE: Heat shrinkable, transparent blue, radiation cross-linked polyvinylidene fluoride.
- 2. SOLDER PREFORM WITH FLUX: SOLDER: TYPE Sn63 per ANSI J-STD-006. FLUX: TYPE ROL1 per ANSI J-STD-004.

## APPLICATION

- 1. This sleeve is designed to terminate 26 through 22 AWG wire connectors with tinned Ø0.64 (Ø0.025) pins, 5.08 (0.200) high.
- 2. Sleeve will recover to 0.76 (0.030) I.D. max.
- 3. This drawing forms part of Raychem Devices Specification Control Drawing D-711-03.

<b>Raychem Interconnect</b> a division of <b>tyce</b> / Electronics 300 Constitution Drive Menlo Park, CA 94025, USA				HERMOFIT DEVICES	Tľ	TITLE : SOLDERSLEEVE STEPPED INSULATION For Burndy UPC Connector				
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS. INCHES DIMENSIONS ARE BETWEEN BRACKETS.						DOCUMENT NO.: <b>D-141-21</b>				
TOLERANCES:	ANGLES: N/A		Raychem reserves the right to amend this			DCR NUMBER:		REPLACES:		
0.00 N/A			drawing at any time. Users should evaluate		D000588		N/A			
0.0 N/A	ROUGHNESS IN		the suitability of the product for their							
0 N/A	MICRON		application.							
DRAWN BY:		DATE:		PROD. REV.		DOC ISSUE:	SCALE:	SIZE:	SHEET:	
M. FORONDA		02-Oct00		F		1	None	А	1 of 1	

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